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## DATASHEET

## **General Description**

The 9DMU0431 is a member of IDT's SOC-Friendly 1.5V Ultra-Low-Power (ULP) PCIe Gen1-2-3 family. Each of the 4 outputs has its own dedicated OE# pin for optimal system control and power management. The part provides asynchronous and glitch-free switching modes.

## **Recommended Application**

2:4 PCIe Gen1-2-3 clock multiplexer

## **Output Features**

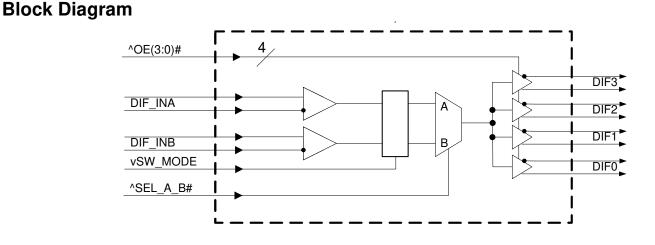
• 4 – Low-Power (LP) HCSL DIF pair

## **Key Specifications**

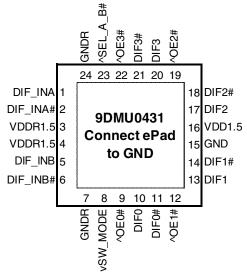
- DIF additive cycle-to-cycle jitter <5ps
- DIF phase jitter is PCIe Gen1-2-3 compliant
- Additive phase jitter @ 125MHz: 535fs rms typical (12kHz to 20MHz)
- DIF output-to-output skew <50ps

## Features/Benefits

- LP-HCSL outputs; save 8 resistors compared to standard HCSL outputs
- 1.5V operation; 31mW typical power consumption
- Selectable asynchronous or glitch-free switching; allows the mux to be selected at power up even if both inputs are not running, then transition to glitch-free switching mode
- · Spread Spectrum Compatible; supports EMI reduction
- OE# pins; support DIF power management
- HCSL differential inputs; can be driven by common clock sources
- 1MHz to 167MHz operating frequency
- Space saving 24-pin 4x4mm VFQFPN; minimal board space



## **Pin Configuration**



#### 24 VFQFPN, 4x4 mm, 0.5mm pitch

^ prefix indicates internal 120KOhm pull up resistor v prefix indicates internal 120KOhm pull down resistor

#### **Power Management Table**

| OEx# Pin | DIF IN  | DIFx     |           |  |
|----------|---------|----------|-----------|--|
|          |         | True O/P | Comp. O/P |  |
| 0        | Running | Running  | Running   |  |
| 1        | Running | Low      | Low       |  |

#### **Power Connections**

| Pin Nu | umber | Description             |  |  |  |
|--------|-------|-------------------------|--|--|--|
| VDD    | GND   | Description             |  |  |  |
| 3      | 24    | Input A receiver analog |  |  |  |
| 4      | 7     | Input B receiver analog |  |  |  |
| 16     | 15    | DIF outputs             |  |  |  |

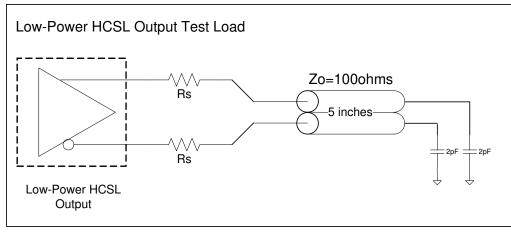
## **Pin Descriptions**

| Pin# | Pin Name | Туре | Pin Description  |
|------|----------|------|--|
| 1    | DIF_INA  | IN   | HCSL Differential True input   |
| 2    | DIF_INA# | IN   | HCSL Differential Complement Input   |
| 3    | VDDR1.5  | PWR  | 1.5V power for differential input clock (receiver). This VDD should be treated as an Analog power rail and filtered appropriately.   |
| 4    | VDDR1.5  | PWR  | 1.5V power for differential input clock (receiver). This VDD should be treated as an Analog power rail and filtered appropriately.   |
| 5    | DIF_INB  | IN   | HCSL Differential True input   |
| 6    | DIF_INB# | IN   | HCSL Differential Complement Input   |
| 7    | GNDR     | GND  | Analog Ground pin for the differential input (receiver)  |
| 8    | vSW_MODE | IN   | Switch Mode. This pin selects either asynchronous or glitch-free switching of the mux. Use asynchronous mode if 0 or 1 of the input clocks is running. Use glitch-free mode if both input clocks are running. This pin has an internal pull down resistor of ~120kohms.<br>0 = asynchronous mode<br>1 = glitch-free mode |
| 9    | ^OE0#    | IN   | Active low input for enabling DIF pair 0. This pin has an internal pull-up resistor.<br>1 =disable outputs, $0 =$ enable outputs   |
| 10   | DIF0     | OUT  | Differential true clock output   |
| 11   | DIF0#    | OUT  | Differential Complementary clock output  |
| 12   | ^OE1#    | IN   | Active low input for enabling DIF pair 1. This pin has an internal pull-up resistor.<br>1 =disable outputs, 0 = enable outputs   |
| 13   | DIF1     | OUT  | Differential true clock output   |
| 14   | DIF1#    | OUT  | Differential Complementary clock output  |
| 15   | GND      | GND  | Ground pin.  |

## Pin Descriptions (cont.)

| Pin# | Pin Name  | Туре | Pin Description  |
|------|-----------|------|--|
| 16   | VDD1.5    | PWR  | Power supply, nominally 1.5V   |
| 17   | DIF2      | OUT  | Differential true clock output   |
| 18   | DIF2#     | OUT  | Differential Complementary clock output  |
| 19   | ^OE2#     | IN   | Active low input for enabling DIF pair 2. This pin has an internal pull-up resistor.                 |
| 19   | AUE2#     | IIN  | 1 =disable outputs, 0 = enable outputs   |
| 20   | DIF3      | OUT  | Differential true clock output   |
| 21   | DIF3#     | OUT  | Differential Complementary clock output  |
| 22   | ^OE3#     | IN   | Active low input for enabling DIF pair 3. This pin has an internal pull-up resistor.                 |
| 22   | ~OE3#     |      | 1 =disable outputs, 0 = enable outputs   |
|      |           |      | Input to select differential input clock A or differential input clock B. This input has an internal |
| 23   | ^SEL_A_B# | IN   | pull-up resistor.  |
|      |           |      | 0 = Input B selected, 1 = Input A selected.  |
| 24   | GNDR      | GND  | Analog Ground pin for the differential input (receiver)  |
| 25   | EPAD      | GND  | Connect to Ground.   |

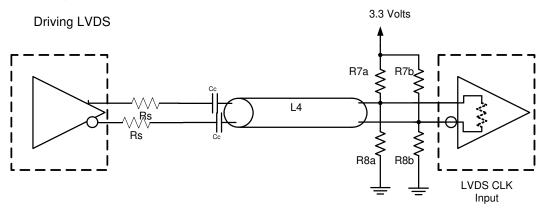
## **Test Loads**



#### Alternate Differential Output Terminations

| Rs | Zo  | Units |
|----|-----|-------|
| 33 | 100 | Ohms  |
| 27 | 85  | Onins |

## **Driving LVDS**



#### Driving LVDS inputs

|           |              | Value             |      |  |
|-----------|--------------|-------------------|------|--|
|           | Receiver has | Receiver does not |      |  |
| Component | termination  | have termination  | Note |  |
| R7a, R7b  | 10K ohm      | 140 ohm           |      |  |
| R8a, R8b  | 5.6K ohm     | 75 ohm            |      |  |
| Cc        | 0.1 uF       | 0.1 uF            |      |  |
| Vcm       | 1.2 volts    | 1.2 volts         |      |  |

## **Electrical Characteristics–Absolute Maximum Ratings**

| PARAMETER                 | SYMBOL          | CONDITIONS                | MIN  | TYP | MAX                  | UNITS | NOTES |
|---------------------------|-----------------|---------------------------|------|-----|----------------------|-------|-------|
| Supply Voltage            | VDDx            |                           | -0.5 |     | 2                    | V     | 1,2   |
| Input Voltage             | V <sub>IN</sub> |                           | -0.5 |     | V <sub>DD</sub> +0.5 | V     | 1,3   |
| Input High Voltage, SMBus | VIHSMB          | SMBus clock and data pins |      |     | 3.3                  | V     | 1     |
| Storage Temperature       | Ts              |                           | -65  |     | 150                  | °C    | 1     |
| Junction Temperature      | Tj              |                           |      |     | 125                  | °C    | 1     |
| Input ESD protection      | ESD prot        | Human Body Model          | 2000 |     |                      | V     | 1     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>3</sup> Not to exceed 2.0V.

# Electrical Characteristics–Input/Supply/Common Parameters–Normal Operating Conditions

 $TA = T_{AMB}$ , Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                                 | SYMBOL                 | CONDITIONS  | MIN           | TYP | МАХ            | UNITS  | NOTES |
|---|------------------------|---|---------------|-----|----------------|--|-------|
| Supply Voltage                            | VDDx                   | Supply voltage for core and analog  | 1.425         | 1.5 | 1.575          | V  |       |
| Ambient Operating<br>Temperature          | T <sub>AMB</sub>       | Industrial range  | -40           | 25  | 85             | °C   | 1     |
| Input High Voltage                        | V <sub>IH</sub>        | Single-ended inputs, except SMBus   | $0.75 V_{DD}$ |     | $V_{DD} + 0.3$ | V  |       |
| Input Low Voltage                         | V <sub>IL</sub>        | Single-ended inputs, except SMBus   | -0.3          |     | $0.25 V_{DD}$  | V  |       |
|   | I <sub>IN</sub>        | Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$  | -5            |     | 5              | uA   |       |
| Input Current                             | I <sub>INP</sub>       | Single-ended inputs<br>$V_{IN} = 0 V$ ; Inputs with internal pull-up resistors<br>$V_{IN} = VDD$ ; Inputs with internal pull-down resistors | -200          |     | 200            | uA   |       |
| Input Frequency                           | F <sub>in</sub>        |   | 1             |     | 167            | MHz  | 2     |
| Pin Inductance                            | L <sub>pin</sub>       |   |               |     | 7              | nH   | 1     |
|   | CIN                    | Logic Inputs, except DIF_IN   | 1.5           |     | 5              | pF   | 1     |
| Capacitance                               | C <sub>INDIF_IN</sub>  | DIF_IN differential clock inputs  | 1.5           |     | 2.7            | pF   | 1,4   |
|   | C <sub>OUT</sub>       | Output pin capacitance  |               |     | 6              | °C<br>V<br>UA<br>uA<br>uA<br>MHz<br>nH<br>pF | 1     |
| Clk Stabilization                         | T <sub>STAB</sub>      | From V <sub>DD</sub> Power-Up and after input clock<br>stabilization or de-assertion of PD# to 1st clock                                    |               |     | 1              | ms   | 1,2   |
| Input SS Modulation<br>Frequency PCIe     | f <sub>MODINPCIe</sub> | Allowable Frequency for PCIe Applications<br>(Triangular Modulation)  | 30            |     | 33             | kHz  |       |
| Input SS Modulation<br>Frequency non-PCIe | f <sub>MODIN</sub>     | Allowable Frequency for non-PCle Applications<br>(Triangular Modulation)  | 0             |     | 66             | kHz  |       |
| OE# Latency                               | t <sub>LATOE#</sub>    | DIF start after OE# assertion<br>DIF stop after OE# deassertion   | 1             |     | 3              | clocks                                       | 1,3   |
| Tfall                                     | t <sub>F</sub>         | Fall time of single-ended control inputs  |               |     | 5              | ns   | 2     |
| Trise                                     | t <sub>R</sub>         | Rise time of single-ended control inputs  |               |     | 5              | ns   | 2     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Control input must be monotonic from 20% to 80% of input swing.

<sup>3</sup>Time from deassertion until outputs are >200 mV

<sup>4</sup> DIF\_IN input

## **Electrical Characteristics–Clock Input Parameters**

TA = T<sub>AMB</sub>, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| Alvid, [-]- <b>7</b>                  |                    |   | 1                     |     |      |       |       |
|---------------------------------------|--------------------|---|-----------------------|-----|------|-------|-------|
| PARAMETER                             | SYMBOL             | CONDITIONS  | MIN                   | TYP | MAX  | UNITS | NOTES |
| Input High Voltage - DIF_IN           | V <sub>IHDIF</sub> | Differential inputs<br>(single-ended measurement)             | 300                   | 750 | 1150 | mV    | 1     |
| Input Low Voltage - DIF_IN            | VILDIF             | Differential inputs<br>(single-ended measurement)             | V <sub>SS</sub> - 300 | 0   | 300  | mV    | 1     |
| Input Common Mode<br>Voltage - DIF_IN | V <sub>COM</sub>   | Common Mode Input Voltage                                     | 200                   |     | 725  | mV    | 1     |
| Input Amplitude - DIF_IN              | V <sub>SWING</sub> | Peak to Peak value (V <sub>IHDIF</sub> - V <sub>ILDIF</sub> ) | 300                   |     | 1450 | mV    | 1     |
| Input Slew Rate - DIF_IN              | dv/dt              | Measured differentially                                       | 0.35                  |     | 8    | V/ns  | 1,2   |
| Input Leakage Current                 | I <sub>IN</sub>    | $V_{IN} = V_{DD}, V_{IN} = GND$                               | -5                    |     | 5    | uA    |       |
| Input Duty Cycle                      | d <sub>tin</sub>   | Measurement from differential wavefrom                        | 45                    | 50  | 55   | %     | 1     |
| Input Jitter - Cycle to Cycle         | J <sub>DIFIn</sub> | Differential Measurement                                      | 0                     |     | 150  | ps    | 1     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Slew rate measured through +/-75mV window centered around differential zero

## **Electrical Characteristics–DIF Low-Power HCSL Outputs**

TA = T<sub>AMB</sub>, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL            | CONDITIONS   | MIN  | TYP  | MAX  | UNITS | NOTES |
|------------------------|-------------------|--|------|------|------|-------|-------|
| Slew rate              | dV/dt             | Scope averaging on, fast setting                       | 1.2  | 2.5  | 4.2  | V/ns  | 1,2,3 |
| Slew rate matching     | ∆dV/dt            | Slew rate matching, Scope averaging on                 |      | 10   | 20   | %     | 1,2,4 |
| Voltage High           | V <sub>HIGH</sub> | Statistical measurement on single-ended signal         | 550  | 761  | 850  | mV    |       |
| Voltage Low            | V <sub>LOW</sub>  | using oscilloscope math function. (Scope averaging on) |      | 33   | 150  |       |       |
| Max Voltage            | Vmax              | Measurement on single ended signal using               |      | 800  | 1150 | mV    |       |
| Min Voltage            | Vmin              | absolute value. (Scope averaging off)                  | -300 | -1   |      | mv    |       |
| Vswing                 | Vswing            | Scope averaging off                                    | 300  | 1457 |      | mV    | 1,2   |
| Crossing Voltage (abs) | Vcross_abs        | Scope averaging off                                    | 250  | 404  | 550  | mV    | 1,5   |
| Crossing Voltage (var) | ∆-Vcross          | Scope averaging off                                    |      | 15   | 140  | mV    | 1,6   |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform

<sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>5</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross\_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting △-Vcross to be smaller than Vcross absolute.

## **Electrical Characteristics–Current Consumption**

TA = T<sub>AMB</sub>, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                | SYMBOL            | CONDITIONS                      | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|-------------------|---------------------------------|-----|-----|-----|-------|-------|
| Operating Supply Current | I <sub>DD</sub>   | VDD, All outputs active @100MHz |     | 19  | 27  | mA    | 1     |
| Powerdown Current        | I <sub>DDPD</sub> | VDD, all outputs disabled       |     | 1.4 | 2.5 | mA    | 1, 2  |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Input clock stopped.

## Electrical Characteristics–Output Duty Cycle, Jitter, Skew and PLL Characteristics

TA = T<sub>AMB.</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| ·;                     |                       |  |      |       |      |       |       |
|------------------------|-----------------------|--|------|-------|------|-------|-------|
| PARAMETER              | SYMBOL                | CONDITIONS                                   | MIN  | TYP   | MAX  | UNITS | NOTES |
| Duty Cycle Distortion  | t <sub>DCD</sub>      | Measured differentially, Bypass Mode @100MHz | -1   | -0.05 | 1    | %     | 1,3   |
| Skew, Input to Output  | t <sub>pdBYP</sub>    | Bypass Mode, V <sub>T</sub> = 50%            | 2046 | 2864  | 4010 | ps    | 1     |
| Skew, Output to Output | t <sub>sk3</sub>      | V <sub>T</sub> = 50%                         |      | 19    | 50   | ps    | 1,4   |
| Jitter, Cycle to cycle | t <sub>icyc-cyc</sub> | Additive Jitter in Bypass Mode               |      | 0.1   | 5    | ps    | 1,2   |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

asured from differential waveform

<sup>4</sup> All outputs at default slew rate

<sup>5</sup> The MIN/TYP/MAX values of each BW setting track each other, i.e., Low BW MAX will never occur with Hi BW MIN.

## **Electrical Characteristics–Phase Jitter Parameters**

TA = T<sub>AMB</sub>, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

|                                       |                        |   |     |         |        | INDUSTRY |          |          |
|---------------------------------------|------------------------|---|-----|---------|--------|----------|----------|----------|
| PARAMETER                             | SYMBOL                 | CONDITIONS                                      | MIN | TYP     | MAX    | LIMIT    | UNITS    | Notes    |
| Additive Phase Jitter,<br>Bypass Mode | t <sub>jphPCIeG1</sub> | PCIe Gen 1                                      |     | 1.3     | 5      | N/A      | ps (p-p) | 1,2,3,5  |
|                                       | t <sub>jphPCleG2</sub> | PCIe Gen 2 Lo Band                              |     | 0.1     | 0.5    | N/A      | ps       | 1,2,3,4, |
|                                       |                        | 10kHz < f < 1.5MHz                              |     |         | 0.5    |          | (rms)    | 5        |
|                                       |                        | PCIe Gen 2 High Band                            |     | 0.1     | 0.6    | N/A      | ps       | 1,2,3,4  |
|                                       |                        | 1.5MHz < f < Nyquist (50MHz)                    |     |         |        |          | (rms)    | 1,2,0,4  |
|                                       | t <sub>jphPCleG3</sub> | PCIe Gen 3                                      |     | 0.170   | 0.3    | N/A      | ps       | 1,2,3,4  |
|                                       |                        | (PLL BW of 2-4 or 2-5MHz, CDR = 10MHz)          |     |         |        |          | (rms)    | 1,2,0,1  |
|                                       | t <sub>jph125M0</sub>  | 125MHz, 1.5MHz to 10MHz, -20dB/decade           | 365 |         |        | fs       |          |          |
|                                       |                        | rollover < 1.5MHz, -40db/decade rolloff > 10MHz |     | 380     | N/A    | (rms)    | 1,6      |          |
|                                       |                        | ,   |     |         |        |          | 、 ,      |          |
|                                       | t <sub>jph125M1</sub>  | 125MHz, 12KHz to 20MHz, -20dB/decade            | 535 | 535 550 | N/A (I | fs       | 1,6      |          |
|                                       |                        | rollover < 12kHz, -40db/decade rolloff > 20MHz  |     |         |        | (rms)    | .,•      |          |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> See http://www.pcisig.com for complete specs

<sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

<sup>4</sup> For RMS figures, additive jitter is calculated by solving the following equation: Additive jitter = SQRT[(total jitter)^2 - (input jitter)^2]

<sup>5</sup> Driven by 9FGU0831 or equivalent

<sup>6</sup> Rohde&Schartz SMA100



## **Marking Diagrams**



Notes:

1. "LOT" denotes the lot number.

2. "YYWW" is the last two digits of the year and week that the part was assembled.

3. Line 2: truncated part number

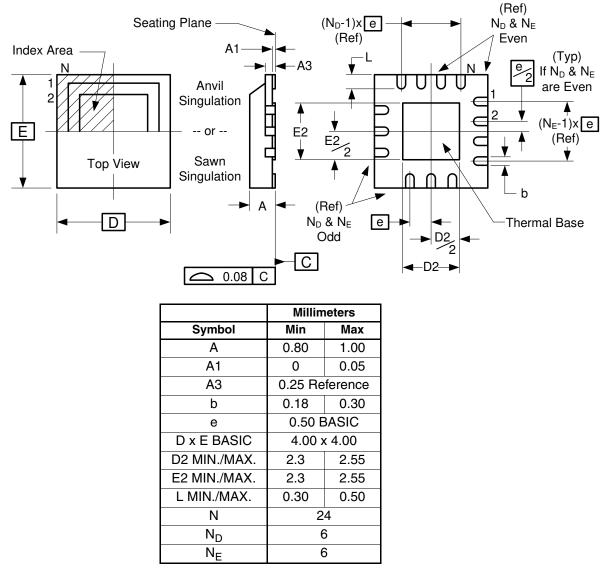
4. "I" denotes industrial temperature grade.

### **Thermal Characteristics**

| PARAMETER          | SYMBOL          | CONDITIONS                      | PKG   | TYP<br>VALUE | UNITS | NOTES |
|--------------------|-----------------|---------------------------------|-------|--------------|-------|-------|
|                    | θ <sub>JC</sub> | Junction to Case                | NLG24 | 42           | °C/W  | 1     |
|                    | $\theta_{Jb}$   | Junction to Base                |       | 2.4          | °C/W  | 1     |
| Thermal Resistance | $\theta_{JA0}$  | Junction to Air, still air      |       | 39           | °C/W  | 1     |
| Thermal Resistance | $\theta_{JA1}$  | Junction to Air, 1 m/s air flow |       | 33           | °C/W  | 1     |
|                    | $\theta_{JA3}$  | Junction to Air, 3 m/s air flow |       | 28           | °C/W  | 1     |
|                    | $\theta_{JA5}$  | Junction to Air, 5 m/s air flow |       | 27           | °C/W  | 1     |

<sup>1</sup>ePad soldered to board

## Package Outline and Package Dimensions (NLG24)



### **Ordering Information**

| Part / Order Number | Shipping Packaging | Package       | Temperature   |
|---------------------|--------------------|---------------|---------------|
| 9DMU0431AKILF       | Tubes              | 24-pin VFQFPN | -40 to +85° C |
| 9DMU0431AKILFT      | Tape and Reel      | 24-pin VFQFPN | -40 to +85° C |

"LF" to the suffix denotes Pb-Free configuration, RoHS compliant.

"A" is the device revision designator (will not correlate with the datasheet revision).

## **Revision History**

| Rev. | Initiator | Issue Date | Description  |     |
|------|-----------|------------|--|-----|
| А    | RDW       | 9/24/2014  | 1. Updated additive phase jitter and General Description | 17  |
|      | אשח       |            | 2. Move to final   | 1,7 |



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